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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Active
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	83
Number of Gates	24000
Voltage - Supply	3V ~ 3.6V, 4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-BQFP
Supplier Device Package	100-PQFP (20x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a42mx16-fpqg100">https://www.e-xfl.com/product-detail/microchip-technology/a42mx16-fpqg100</a>

- VCCA = Power supply in volts (V)
- F = Switching frequency in megahertz (MHz)

### 3.4.4 Equivalent Capacitance

Equivalent capacitance is calculated by measuring ICCactive at a specified frequency and voltage for each circuit component of interest. Measurements have been made over a range of frequencies at a fixed value of VCC. Equivalent capacitance is frequency-independent, so the results can be used over a wide range of operating conditions. Equivalent capacitance values are shown below.

### 3.4.5 C<sub>EQ</sub> Values for Microsemi MX FPGAs

Modules (C<sub>EQM</sub>)3.5

Input Buffers (C<sub>EQI</sub>)6.9

Output Buffers (C<sub>EQO</sub>)18.2

Routed Array Clock Buffer Loads (C<sub>EQCR</sub>)1.4

To calculate the active power dissipated from the complete design, the switching frequency of each part of the logic must be known. The equation below shows a piece-wise linear summation over all components.

$$\text{Power} = \text{VCCA}^2 * [(m * C_{EQM} * f_m)_{\text{modules}} + (n * C_{EQI} * f_n)_{\text{inputs}} + (p * (C_{EQO} + C_L) * f_p)_{\text{outputs}} + \\ 0.5 * (q_1 * C_{EQCR} * f_{q1})_{\text{routed\_Clk1}} + (r_1 * f_{q1})_{\text{routed\_Clk1}} + \\ 0.5 * (q_2 * C_{EQCR} * f_{q2})_{\text{routed\_Clk2}} + (r_2 * f_{q2})_{\text{routed\_Clk2}}(2)]$$

**EQ 3**

where:

m = Number of logic modules switching at frequency f<sub>m</sub>

n = Number of input buffers switching at frequency f<sub>n</sub>

p = Number of output buffers switching at frequency f<sub>p</sub>

q<sub>1</sub> = Number of clock loads on the first routed array clock

q<sub>2</sub> = Number of clock loads on the second routed array clock

r<sub>1</sub> = Fixed capacitance due to first routed array clock

r<sub>2</sub> = Fixed capacitance due to second routed array clock

C<sub>EQM</sub> = Equivalent capacitance of logic modules in pF

C<sub>EQI</sub> = Equivalent capacitance of input buffers in pF

C<sub>EQO</sub> = Equivalent capacitance of output buffers in pF

C<sub>EQCR</sub> = Equivalent capacitance of routed array clock in pF

C<sub>L</sub> = Output load capacitance in pF

f<sub>m</sub> = Average logic module switching rate in MHz

f<sub>n</sub> = Average input buffer switching rate in MHz

f<sub>p</sub> = Average output buffer switching rate in MHz

f<sub>q1</sub> = Average first routed array clock rate in MHz

**Table 34 • A40MX02 Timing Characteristics (Nominal 5.0 V Operation) (continued)**  
**(Worst-Case Commercial Conditions, VCC = 4.75 V, TJ = 70°C)**

<b>Parameter / Description</b>	<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>TTL Output Module Timing<sup>4</sup></b>											
t <sub>DLH</sub>	Data-to-Pad HIGH	3.3	3.8	4.3	5.1	7.2	ns				
t <sub>DHL</sub>	Data-to-Pad LOW	4.0	4.6	5.2	6.1	8.6	ns				
t <sub>ENZH</sub>	Enable Pad Z to HIGH	3.7	4.3	4.9	5.8	8.0	ns				
t <sub>ENZL</sub>	Enable Pad Z to LOW	4.7	5.4	6.1	7.2	10.1	ns				
t <sub>ENHZ</sub>	Enable Pad HIGH to Z	7.9	9.1	10.4	12.2	17.1	ns				
t <sub>ENLZ</sub>	Enable Pad LOW to Z	5.9	6.8	7.7	9.0	12.6	ns				
d <sub>TLH</sub>	Delta LOW to HIGH	0.02	0.02	0.03	0.03	0.04	ns/pF				
d <sub>THL</sub>	Delta HIGH to LOW	0.03	0.03	0.03	0.04	0.06	ns/pF				
<b>CMOS Output Module Timing<sup>4</sup></b>											
t <sub>DLH</sub>	Data-to-Pad HIGH	3.9	4.5	5.1	6.05	8.5	ns				
t <sub>DHL</sub>	Data-to-Pad LOW	3.4	3.9	4.4	5.2	7.3	ns				
t <sub>ENZH</sub>	Enable Pad Z to HIGH	3.4	3.9	4.4	5.2	7.3	ns				
t <sub>ENZL</sub>	Enable Pad Z to LOW	4.9	5.6	6.4	7.5	10.5	ns				
t <sub>ENHZ</sub>	Enable Pad HIGH to Z	7.9	9.1	10.4	12.2	17.0	ns				
t <sub>ENLZ</sub>	Enable Pad LOW to Z	5.9	6.8	7.7	9.0	12.6	ns				
d <sub>TLH</sub>	Delta LOW to HIGH	0.03	0.04	0.04	0.05	0.07	ns/pF				
d <sub>THL</sub>	Delta HIGH to LOW	0.02	0.02	0.03	0.03	0.04	ns/pF				

1. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance
2. Set-up times assume fanout of 3. Further testing information can be obtained from the Timer utility
3. The hold time for the DFME1A macro may be greater than 0 ns. Use the Timer tool from the Designer software to check the hold time for this macro.
4. Delays based on 35pF loading

**Table 35 • A40MX02 Timing Characteristics (Nominal 3.3 V Operation)**  
**(Worst-Case Commercial Conditions, VCC = 3.0 V, TJ = 70°C)**

<b>Parameter / Description</b>	<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Logic Module Propagation Delays</b>											
t <sub>PD1</sub>	Single Module	1.7	2.0	2.3	2.7	3.7	ns				
t <sub>PD2</sub>	Dual-Module Macros	3.7	4.3	4.9	5.7	8.0	ns				
t <sub>CO</sub>	Sequential Clock-to-Q	1.7	2.0	2.3	2.7	3.7	ns				
t <sub>GO</sub>	Latch G-to-Q	1.7	2.0	2.3	2.7	3.7	ns				
t <sub>RS</sub>	Flip-Flop (Latch) Reset-to-Q	1.7	2.0	2.3	2.7	3.7	ns				
<b>Logic Module Predicted Routing Delays<sup>1</sup></b>											

**Table 39 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

Parameter / Description		-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>RD4</sub>	FO = 4 Routing Delay			1.9		2.1		2.4		2.9		4.0 ns
t <sub>RD8</sub>	FO = 8 Routing Delay			3.2		3.6		4.1		4.8		6.7 ns
<b>Logic Module Sequential Timing<sup>3, 4</sup></b>												
t <sub>SUD</sub>	Flip-Flop (Latch) Data Input Set-Up	0.5		0.5		0.6		0.7		0.9		ns
t <sub>HD</sub>	Flip-Flop (Latch) Data Input Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	0.6		0.6		0.7		0.8		1.2		ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width		4.7		5.3		6.0		7.0		9.8	ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width		6.2		6.9		7.8		9.2		12.9	ns
t <sub>A</sub>	Flip-Flop Clock Input Period	5.0		5.6		6.2		7.1		9.9		ns
t <sub>INH</sub>	Input Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>NSU</sub>	Input Buffer Latch Set-Up	0.3		0.3		0.3		0.4		0.6		ns
t <sub>OUTH</sub>	Output Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>OUTSU</sub>	Output Buffer Latch Set-Up	0.3		0.3		0.3		0.4		0.6		ns
f <sub>MAX</sub>	Flip-Flop (Latch) Clock Frequency		161		146		135		117		70	MHz

**Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>RD3</sub>	FO = 3 Routing Delay		1.3		1.4		1.6		1.9		2.7 ns
t <sub>RD4</sub>	FO = 4 Routing Delay		1.6		1.7		2.0		2.3		3.2 ns
t <sub>RD8</sub>	FO = 8 Routing Delay		2.6		2.9		3.2		3.8		5.3 ns
<b>Logic Module Sequential Timing<sup>3,4</sup></b>											
t <sub>SUD</sub>	Flip-Flop (Latch) Data Input Set-Up		0.3		0.4		0.4		0.5		0.7 ns
t <sub>HD</sub>	Flip-Flop (Latch) Data Input Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	0.7		0.8		0.9		1.0		1.4	ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width	3.4		3.8		4.3		5.0		7.1	ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width	4.5		5.0		5.6		6.6		9.2	ns
t <sub>A</sub>	Flip-Flop Clock Input Period	6.8		7.6		8.6		10.1		14.1	ns
t <sub>INH</sub>	Input Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>INSU</sub>	Input Buffer Latch Set-Up	0.5		0.5		0.6		0.7		1.0	ns
t <sub>OUTH</sub>	Output Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>OUTSU</sub>	Output Buffer Latch Set-Up	0.5		0.5		0.6		0.7		1.0	ns
f <sub>MAX</sub>	Flip-Flop (Latch) Clock Frequency	215		195		179		156		94	MHz
<b>Input Module Propagation Delays</b>											
t <sub>INYH</sub>	Pad-to-Y HIGH		1.1		1.2		1.3		1.6		2.2 ns
t <sub>INYL</sub>	Pad-to-Y LOW		0.8		0.9		1.0		1.2		1.7 ns
t <sub>INGH</sub>	G to Y HIGH		1.4		1.6		1.8		2.1		2.9 ns
t <sub>INGL</sub>	G to Y LOW		1.4		1.6		1.8		2.1		2.9 ns
<b>Input Module Predicted Routing Delays<sup>2</sup></b>											
t <sub>IRD1</sub>	FO = 1 Routing Delay		1.8		2.0		2.3		2.7		4.0 ns
t <sub>IRD2</sub>	FO = 2 Routing Delay		2.1		2.3		2.6		3.1		4.3 ns
t <sub>IRD3</sub>	FO = 3 Routing Delay		2.3		2.6		3.0		3.5		4.9 ns
t <sub>IRD4</sub>	FO = 4 Routing Delay		2.6		3.0		3.3		3.9		5.4 ns
t <sub>IRD8</sub>	FO = 8 Routing Delay		3.6		4.0		4.6		5.4		7.5 ns
<b>Global Clock Network</b>											
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32	2.6		2.9		3.3		3.9		5.4 ns
		FO = 384	2.9		3.2		3.6		4.3		6.0 ns
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32	3.8		4.2		4.8		5.6		7.8 ns
		FO = 384	4.5		5.0		5.6		6.6		9.2 ns
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	3.2		3.5		4.0		4.7		6.6 ns
		FO = 384	3.7		4.1		4.6		5.4		7.6 ns

**Table 41 • A42MX16 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

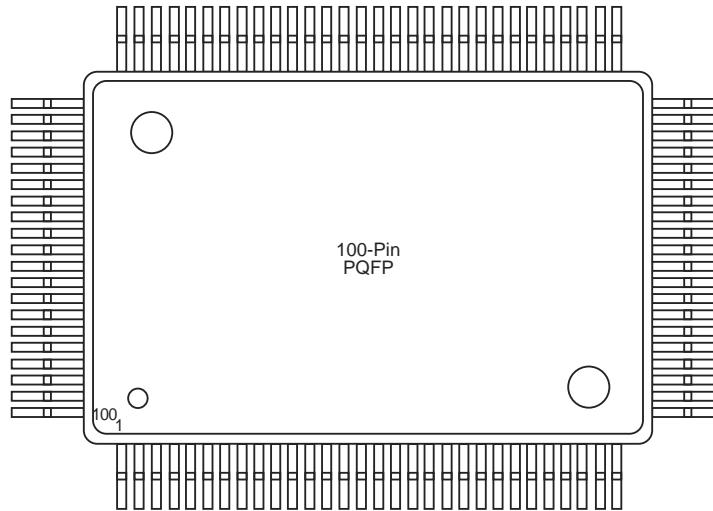
Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PWL</sub> Minimum Pulse Width LOW	FO = 32	5.3	5.9	6.7	7.8	11.0	ns				
	FO = 384	6.2	6.9	7.9	9.2	12.9	ns				
t <sub>CKSW</sub> Maximum Skew	FO = 32		0.5	0.5	0.6	0.7	1.0	ns			
	FO = 384		2.2	2.4	2.7	3.2	4.5	ns			
t <sub>SUEXT</sub> Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	0.0	ns			
	FO = 384	0.0	0.0	0.0	0.0	0.0	0.0	ns			
t <sub>HEXT</sub> Input Latch External Hold	FO = 32	3.9	4.3	4.9	5.7	8.0	ns				
	FO = 384	4.5	4.9	5.6	6.6	9.2	ns				
t <sub>P</sub> Minimum Period	FO = 32	7.0	7.8	8.4	9.7	16.2	ns				
	FO = 384	7.7	8.6	9.3	10.7	17.8	ns				
f <sub>MAX</sub> Maximum Frequency	FO = 32		142	129	119	103	62	MHz			
	FO = 384		129	117	108	94	56	MHz			
<b>TTL Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub> Data-to-Pad HIGH			3.5	3.9	4.4	5.2	7.3	ns			
t <sub>DHL</sub> Data-to-Pad LOW			4.1	4.6	5.2	6.1	8.6	ns			
t <sub>ENZH</sub> Enable Pad Z to HIGH			3.8	4.2	4.8	5.6	7.8	ns			
t <sub>ENZL</sub> Enable Pad Z to LOW			4.2	4.6	5.3	6.2	8.7	ns			
t <sub>ENHZ</sub> Enable Pad HIGH to Z			7.6	8.4	9.5	11.2	15.7	ns			
t <sub>ENLZ</sub> Enable Pad LOW to Z			7.0	7.8	8.8	10.4	14.5	ns			
t <sub>GLH</sub> G-to-Pad HIGH			4.8	5.3	6.0	7.2	10.0	ns			
t <sub>GHL</sub> G-to-Pad LOW			4.8	5.3	6.0	7.2	10.0	ns			
t <sub>LCO</sub> I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading			8.0	8.9	10.1	11.9	16.7	ns			
t <sub>ACO</sub> Array Clock-to-Out (Pad-to-Pad), 64 Clock Loading			11.3	12.5	14.2	16.7	23.3	ns			
d <sub>TLH</sub> Capacitive Loading, LOW to HIGH			0.04	0.04	0.05	0.06	0.08	ns/pF			
d <sub>THL</sub> Capacitive Loading, HIGH to LOW			0.05	0.05	0.06	0.07	0.10	ns/pF			
<b>CMOS Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub> Data-to-Pad HIGH			4.5	5.0	5.6	6.6	9.3	ns			
t <sub>DHL</sub> Data-to-Pad LOW			3.4	3.8	4.3	5.1	7.1	ns			
t <sub>ENZH</sub> Enable Pad Z to HIGH			3.8	4.2	4.8	5.6	7.8	ns			
t <sub>ENZL</sub> Enable Pad Z to LOW			4.2	4.6	5.3	6.2	8.7	ns			
t <sub>ENHZ</sub> Enable Pad HIGH to Z			7.6	8.4	9.5	11.2	15.7	ns			
t <sub>ENLZ</sub> Enable Pad LOW to Z			7.0	7.8	8.8	10.4	14.5	ns			
t <sub>GLH</sub> G-to-Pad HIGH			7.1	7.9	8.9	10.5	14.7	ns			
t <sub>GHL</sub> G-to-Pad LOW			7.1	7.9	8.9	10.5	14.7	ns			
t <sub>LCO</sub> I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading			8.0	8.9	10.1	11.9	16.7	ns			

**Table 44 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)**

<b>Parameter / Description</b>	<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>TTL Output Module Timing<sup>5</sup> (Continued)</b>											
t <sub>ENLZ</sub>	Enable Pad LOW to Z	4.9	5.5	6.2	7.3	10.2	ns				
t <sub>GLH</sub>	G-to-Pad HIGH	2.9	3.3	3.7	4.4	6.1	ns				
t <sub>GHL</sub>	G-to-Pad LOW	2.9	3.3	3.7	4.4	6.1	ns				
t <sub>LSU</sub>	I/O Latch Output Set-Up	0.5	0.5	0.6	0.7	1.0	ns				
t <sub>LH</sub>	I/O Latch Output Hold	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>LCO</sub>	I/O Latch Clock-to-Out (Pad-to-Pad) 32 I/O	5.7	6.3	7.1	8.4	11.8	ns				
t <sub>ACO</sub>	Array Latch Clock-to-Out (Pad-to-Pad) 32 I/O	7.8	8.6	9.8	11.5	16.1	ns				
d <sub>TLH</sub>	Capacitive Loading, LOW to HIGH	0.07	0.08	0.09	0.10	0.14	ns/pF				
d <sub>THL</sub>	Capacitive Loading, HIGH to LOW	0.07	0.08	0.09	0.10	0.14	ns/pF				

**Table 49 • PL84**

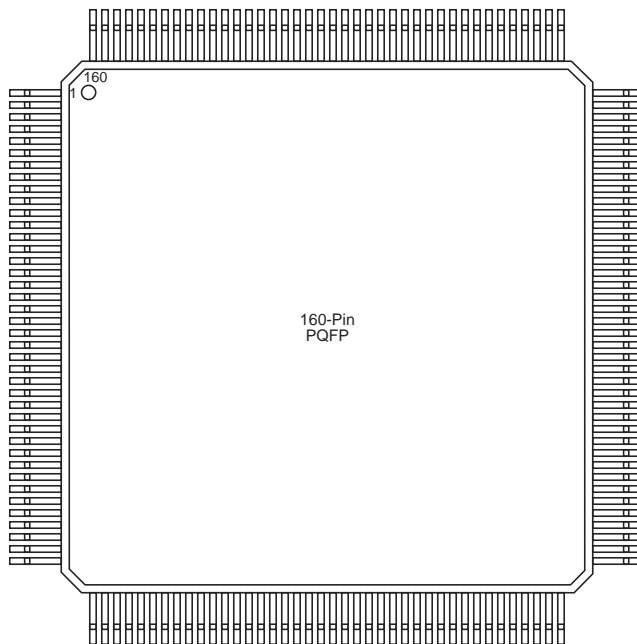
<b>PL84</b>	<b>Pin Number</b>	<b>A40MX04 Function</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
84	I/O	VCCA	VCCA	VCCA	VCCA

**Figure 41 • PQ100****Table 50 • PQ 100**

<b>PQ100</b>	<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>
1	NC	NC	I/O	I/O	
2	NC	NC	DCLK, I/O	DCLK, I/O	
3	NC	NC	I/O	I/O	
4	NC	NC	MODE	MODE	
5	NC	NC	I/O	I/O	
6	PRB, I/O	PRB, I/O	I/O	I/O	
7	I/O	I/O	I/O	I/O	
8	I/O	I/O	I/O	I/O	
9	I/O	I/O	GND	GND	
10	I/O	I/O	I/O	I/O	
11	I/O	I/O	I/O	I/O	
12	I/O	I/O	I/O	I/O	
13	GND	GND	I/O	I/O	
14	I/O	I/O	I/O	I/O	
15	I/O	I/O	I/O	I/O	
16	I/O	I/O	VCCA	VCCA	
17	I/O	I/O	VCCI	VCCI	
18	I/O	I/O	I/O	I/O	

**Table 51 • PQ144**

<b>PQ144</b>	
<b>Pin Number</b>	<b>A42MX09 Function</b>
6	I/O
7	I/O
8	I/O
9	GNDQ
10	GNDI
11	NC
12	I/O
13	I/O
14	I/O
15	I/O
16	I/O
17	I/O
18	VSV
19	VCC
20	VCCI
21	NC
22	I/O
23	I/O
24	I/O
25	I/O
26	I/O
27	I/O
28	GND
29	GNDI
30	NC
31	I/O
32	I/O
33	I/O
34	I/O
35	I/O
36	I/O
37	BININ
38	BINOUT
39	I/O
40	I/O
41	I/O
42	I/O

**Figure 43 • PQ160****Table 52 • PQ160**

PQ160	A42MX09 Function	A42MX16 Function	A42MX24 Function
1	I/O	I/O	I/O
2	DCLK, I/O	DCLK, I/O	DCLK, I/O
3	NC	I/O	I/O
4	I/O	I/O	WD, I/O
5	I/O	I/O	WD, I/O
6	NC	VCCI	VCCI
7	I/O	I/O	I/O
8	I/O	I/O	I/O
9	I/O	I/O	I/O
10	NC	I/O	I/O
11	GND	GND	GND
12	NC	I/O	I/O
13	I/O	I/O	WD, I/O
14	I/O	I/O	WD, I/O
15	I/O	I/O	I/O
16	PRB, I/O	PRB, I/O	PRB, I/O
17	I/O	I/O	I/O
18	CLKB, I/O	CLKB, I/O	CLKB, I/O
19	I/O	I/O	I/O
20	VCCA	VCCA	VCCA

**Table 52 • PQ160**

<b>PQ160</b>	<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
	58	VCCI	VCCI	VCCI
	59	GND	GND	GND
	60	VCCA	VCCA	VCCA
	61	LP	LP	LP
	62	I/O	I/O	TCK, I/O
	63	I/O	I/O	I/O
	64	GND	GND	GND
	65	I/O	I/O	I/O
	66	I/O	I/O	I/O
	67	I/O	I/O	I/O
	68	I/O	I/O	I/O
	69	GND	GND	GND
	70	NC	I/O	I/O
	71	I/O	I/O	I/O
	72	I/O	I/O	I/O
	73	I/O	I/O	I/O
	74	I/O	I/O	I/O
	75	NC	I/O	I/O
	76	I/O	I/O	I/O
	77	NC	I/O	I/O
	78	I/O	I/O	I/O
	79	NC	I/O	I/O
	80	GND	GND	GND
	81	I/O	I/O	I/O
	82	SDO, I/O	SDO, I/O	SDO, TDO, I/O
	83	I/O	I/O	WD, I/O
	84	I/O	I/O	WD, I/O
	85	I/O	I/O	I/O
	86	NC	VCCI	VCCI
	87	I/O	I/O	I/O
	88	I/O	I/O	WD, I/O
	89	GND	GND	GND
	90	NC	I/O	I/O
	91	I/O	I/O	I/O
	92	I/O	I/O	I/O
	93	I/O	I/O	I/O
	94	I/O	I/O	I/O

**Table 52 • PQ160**

<b>PQ160</b>	<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
	132	I/O	I/O	I/O
	133	I/O	I/O	I/O
	134	I/O	I/O	I/O
	135	NC	VCCA	VCCA
	136	I/O	I/O	I/O
	137	I/O	I/O	I/O
	138	NC	VCCA	VCCA
	139	VCCI	VCCI	VCCI
	140	GND	GND	GND
	141	NC	I/O	I/O
	142	I/O	I/O	I/O
	143	I/O	I/O	I/O
	144	I/O	I/O	I/O
	145	GND	GND	GND
	146	NC	I/O	I/O
	147	I/O	I/O	I/O
	148	I/O	I/O	I/O
	149	I/O	I/O	I/O
	150	NC	VCCA	VCCA
	151	NC	I/O	I/O
	152	NC	I/O	I/O
	153	NC	I/O	I/O
	154	NC	I/O	I/O
	155	GND	GND	GND
	156	I/O	I/O	I/O
	157	I/O	I/O	I/O
	158	I/O	I/O	I/O
	159	MODE	MODE	MODE
	160	GND	GND	GND

**Table 54 • PQ240**

<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
52	VCCI
53	I/O
54	WD, I/O
55	WD, I/O
56	I/O
57	SDI, I/O
58	I/O
59	VCCA
60	GND
61	GND
62	I/O
63	I/O
64	I/O
65	I/O
66	I/O
67	I/O
68	I/O
69	I/O
70	I/O
71	VCCI
72	I/O
73	I/O
74	I/O
75	I/O
76	I/O
77	I/O
78	I/O
79	I/O
80	I/O
81	I/O
82	I/O
83	I/O
84	I/O
85	VCCA
86	I/O
87	I/O
88	VCCA

**Table 54 • PQ240**

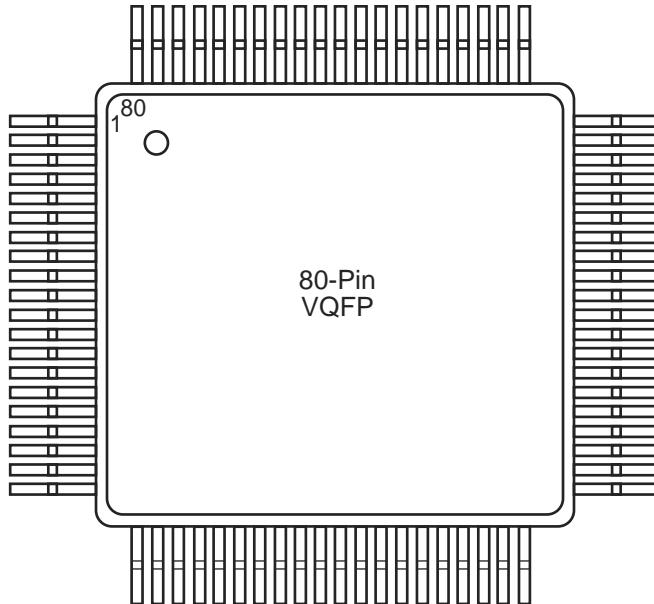
<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
126	WD, I/O
127	I/O
128	VCCI
129	I/O
130	I/O
131	I/O
132	WD, I/O
133	WD, I/O
134	I/O
135	QCLKB, I/O
136	I/O
137	I/O
138	I/O
139	I/O
140	I/O
141	I/O
142	WD, I/O
143	WD, I/O
144	I/O
145	I/O
146	I/O
147	I/O
148	I/O
149	I/O
150	VCCI
151	VCCA
152	GND
153	I/O
154	I/O
155	I/O
156	I/O
157	I/O
158	I/O
159	WD, I/O
160	WD, I/O
161	I/O
162	I/O

**Table 54 • PQ240**

<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
163	WD, I/O
164	WD, I/O
165	I/O
166	QCLKA, I/O
167	I/O
168	I/O
169	I/O
170	I/O
171	I/O
172	VCCI
173	I/O
174	WD, I/O
175	WD, I/O
176	I/O
177	I/O
178	TDI, I/O
179	TMS, I/O
180	GND
181	VCCA
182	GND
183	I/O
184	I/O
185	I/O
186	I/O
187	I/O
188	I/O
189	I/O
190	I/O
191	I/O
192	VCCI
193	I/O
194	I/O
195	I/O
196	I/O
197	I/O
198	I/O
199	I/O

**Table 54 • PQ240**

<b>PQ240</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
237	GND
238	MODE
239	VCCA
240	GND

**Figure 46 • VQ80****Table 55 • VQ80**

<b>VQ80</b>		
<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>
1	I/O	I/O
2	NC	I/O
3	NC	I/O
4	NC	I/O
5	I/O	I/O
6	I/O	I/O
7	GND	GND
8	I/O	I/O
9	I/O	I/O
10	I/O	I/O
11	I/O	I/O
12	I/O	I/O

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
C3	GND
C4	I/O
C5	WD, I/O
C6	I/O
C7	QCLKC, I/O
C8	I/O
C9	I/O
C10	CLKB
C11	PRA, I/O
C12	WD, I/O
C13	I/O
C14	QCLKD, I/O
C15	I/O
C16	WD, I/O
C17	SDI, I/O
C18	I/O
C19	I/O
C20	I/O
D1	I/O
D2	I/O
D3	I/O
D4	I/O
D5	VCCI
D6	I/O
D7	I/O
D8	VCCA
D9	WD, I/O
D10	VCCI
D11	I/O
D12	VCCI
D13	I/O
D14	VCCI
D15	I/O
D16	VCCA
D17	GND
D18	I/O
D19	I/O

**Table 60 • BG272**

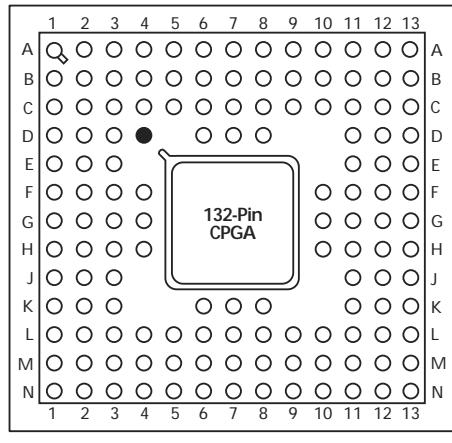
<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
J9	GND
J10	GND
J11	GND
J12	GND
J17	VCCA
J18	I/O
J19	I/O
J20	I/O
K1	I/O
K2	I/O
K3	I/O
K4	VCCI
K9	GND
K10	GND
K11	GND
K12	GND
K17	I/O
K18	VCCA
K19	VCCA
K20	LP
L1	I/O
L2	I/O
L3	VCCA
L4	VCCA
L9	GND
L10	GND
L11	GND
L12	GND
L17	VCCI
L18	I/O
L19	I/O
L20	TCK, I/O
M1	I/O
M2	I/O
M3	I/O
M4	VCCI
M9	GND

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
V16	I/O
V17	I/O
V18	SDO, TDO, I/O
V19	I/O
V20	I/O
W1	GND
W2	GND
W3	I/O
W4	TMS, I/O
W5	I/O
W6	I/O
W7	I/O
W8	WD, I/O
W9	WD, I/O
W10	I/O
W11	I/O
W12	I/O
W13	WD, I/O
W14	I/O
W15	I/O
W16	WD, I/O
W17	I/O
W18	WD, I/O
W19	GND
W20	GND
Y1	GND
Y2	GND
Y3	I/O
Y4	TDI, I/O
Y5	WD, I/O
Y6	I/O
Y7	QCLKA, I/O
Y8	I/O
Y9	I/O
Y10	I/O
Y11	I/O
Y12	I/O

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
Y13	I/O
Y14	I/O
Y15	I/O
Y16	I/O
Y17	I/O
Y18	WD, I/O
Y19	GND
Y20	GND

**Figure 52 • PG132**

● Orientation Pin

**Table 61 • PG132**

<b>PG132</b>	
<b>Pin Number</b>	<b>A42MX09 Function</b>
-	PMPOUT
B2	I/O
A1	MODE
B1	I/O
D3	I/O
C2	I/O
C1	I/O
D2	I/O
D1	I/O
E2	I/O
E1	I/O
F3	I/O

**Figure 53 • CQ172****Table 62 • CQ172**

CQ172	
Pin Number	A42MX16 Function
1	MODE
2	I/O
3	I/O
4	I/O
5	I/O
6	I/O
7	GND
8	I/O
9	I/O
10	I/O
11	I/O
12	VCC
13	I/O
14	I/O
15	I/O
16	I/O
17	GND
18	I/O
19	I/O
20	I/O